

ELASTOMER TACK CHART

Technical Datasheet

RECOMMENDED TACK LEVEL				
Device Surface in Contact with the Elastomer				
	- <u>Highly Polished Flat Surface.</u> Super Polished Glass. Freshly Polished or Cleaned Surfaces. - <u>Polished Thin & Large Surface Area Parts.</u> Small, Thin Diode Laser Bar. GaAs, <u>GaN</u> & InP Die.	- <u>Polished Flat Surfaces.</u> Polished Silicon Wafer. Diode Lasers. Small Optics with Polished Surface. Flex Circuit with Smooth Flat Surface. CMOS Sensor Die. Optical Filters. Planar Lightwave Circuits.	- <u>Etched or Ground Flat Surfaces.</u> Raw Silicon Wafer. Flat Ground Glass. QFN Packages. Flat Machined Metal Surfaces. - <u>Heavier Flat Polished Surfaces.</u> - <u>Heavier Flat Polished Surfaces.</u> - <u>Flat PCB's.</u> - <u>Flat ercB's.</u> - <u>Flat Axis Collimating Lenses.</u>	- <u>Porous Flat Surface.</u> Ceramic Packages & Substrates. - <u>Limited Surface Contact Area.</u> BGA. Bump die. Stents. Thin Tubes or Needles. AFM Cantilevers. Small Ball Lenses. Platinum Marker Bands. Medical Coils.
GEL	Cet Pak XT	XL Git Pax	eri Pak 4 5 6d Pak 6	8
VERTEC		(FPEd FPEd END	Entran EHOA	FK79 FK79 EH06
	Ultra-Low Tack	Low Tack	Medium Tack	High Tack

Note: XL used for VR products and X0, X5 used for AD, BD, and CD products.

EH02 and EH04 used for APV, BPV and VRP products.

EH06 used for VRP products only

EH07 used for APV / BPV products only.

EH02, EH04, EH06 and EH07 were static dissipative materials.



GEL-PAK

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